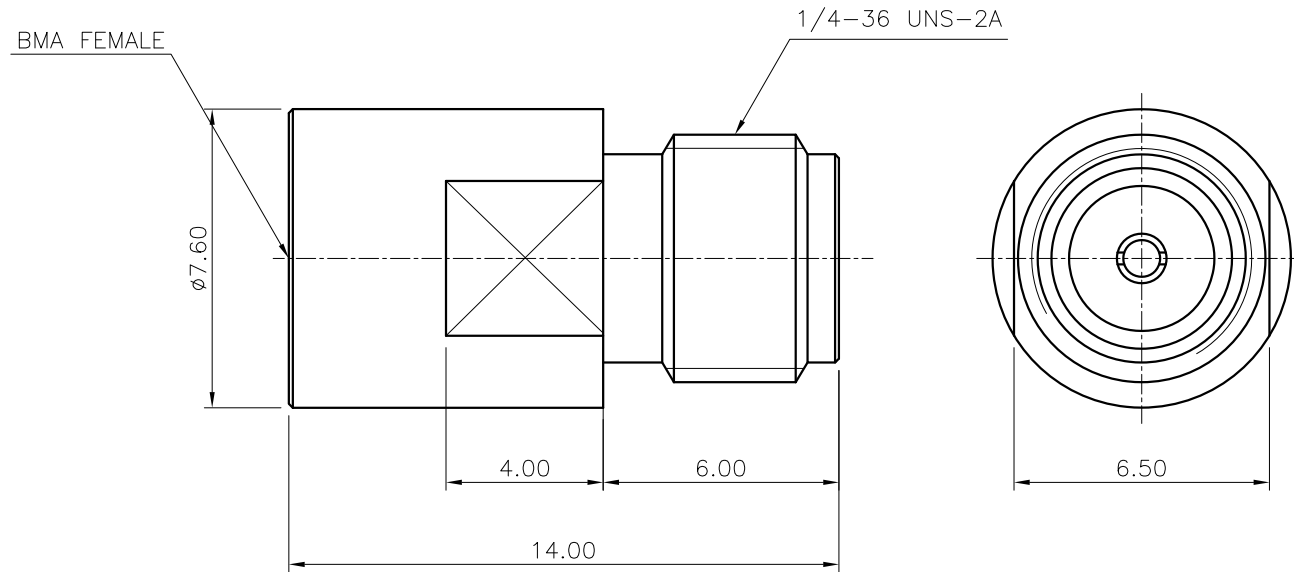


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1 R	Initial Registration	S.H.KIM		2023.07.06.



4	PLATE SPRING	1	BeCu	Gold Plate	DPS00002-5/1
3	INSULATOR	1	TEFLON		DIN01349-N/1
2	CONTACT	1	BeCu	Gold Plate	DAC00256-5/1
1	BODY	1	MBsBD	Nickel Plate	DAD00256-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

* 주 기

1. 삽입탈력 Spec (상대물 외경 Ø5.35) 기준
- 삽입탈력Spec : 1.20~1.3Kgf

TOLERANCE	Decimal ±0.2	DATE 2023. 07. 06.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL -		CHECKED BY			TITLE SMA50 (J) BMA (J) ST
		DRAWN BY S. H. KIM			
FINISH -		SCALE 5/1	UNIT mm		A4
		DWG NO. AD00493-7/2			
		REVISION I R			SHEET 1 of 1